

# N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)	
20	0.037 at V <sub>GS</sub> = 4.5 V	6	5.6 nC	
20	0.065 at V <sub>GS</sub> = 2.5V	6		

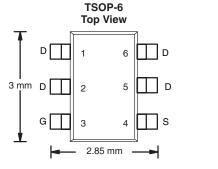
#### **FEATURES**

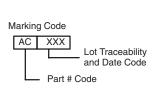
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

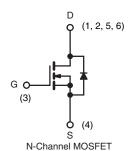


#### **APPLICATIONS**

- Load Switch for Portable Applications
- Small High Frequency DC/DC converter







Ordering Information: Si3446ADV-T1-E3 (Lead (Pb)-free)

Si3446ADV-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS $T_{A}$	= 25 °C, unless other	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	20	V		
Gate-Source Voltage		$V_{GS}$	± 12	V	
	T <sub>C</sub> = 25 °C		6 <sup>a</sup>		
Continuous Drain Current (T, = 150 °C)	T <sub>C</sub> = 70 °C	1 , 🗀	5.9		
Continuous Dialit Current (1) = 150°C)	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	5.8 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		4.7 <sup>b, c</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	20		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	1	2.7		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	1.7 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		3.2		
Mayimum Dayyar Dissination	T <sub>C</sub> = 70 °C		2.1	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C		1.25 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 5 s	R <sub>thJA</sub>	51	62.5	°C/W	
Maximum Junction-to-Foot	Steady State	$R_{thJF}$	32	39	C/VV	

#### Notes:

- a. Package Limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s
- d. Maximum under steady state conditions is 110 °C/W.

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Parameter	Symbol Test Conditions		Min.	Тур.	Max.	Unit	
Static	-				I	l.	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Vpe/Ti		21.5		\//00	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 4		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.8		1.8	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zarra Oata Valtana Daria Oarrant	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			1	μΑ	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	20			Α	
	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 5.8 \text{ A}$		0.031	0.037	Ω	
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = 2.5 \text{ V}, I_D = 1.5 \text{ A}$		0.053	0.065		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 5.8 A		15		S	
Dynamic <sup>b</sup>				•		1	
Input Capacitance	C <sub>iss</sub>			640		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		110			
Reverse Transfer Capacitance	C <sub>rss</sub>			60			
Total Gate Charge	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5.8 \text{ A}$		13	20	nC	
		V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 5.8 A		5.6	9		
Gate-Source Charge	$Q_{gs}$			1.45			
Gate-Drain Charge	Q <sub>gd</sub>			1.4			
Gate Resistance	$R_g$	f = 1 MHz		2.8		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			50	75	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 2.1 $\Omega$		120	180		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong 4.7 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		30	45		
Fall Time	t <sub>f</sub>			40	60		
Turn-On Delay Time	t <sub>d(on)</sub>			7	15		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 2.1 $\Omega$		86	130		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong 4.7 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		25	40		
Fall Time	t <sub>f</sub>			10	15		
<b>Drain-Source Body Diode Characterist</b>	ics						
Continous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			6	A	
Pulse Diode Forward Current	I <sub>SM</sub>				20		
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 4.7 A, V <sub>GS</sub> = 0 V		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			21	40	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$I_F = 4.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		12	25	nC	
Reverse Recovery Fall Time	t <sub>a</sub>			13		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			8			

#### Notes:

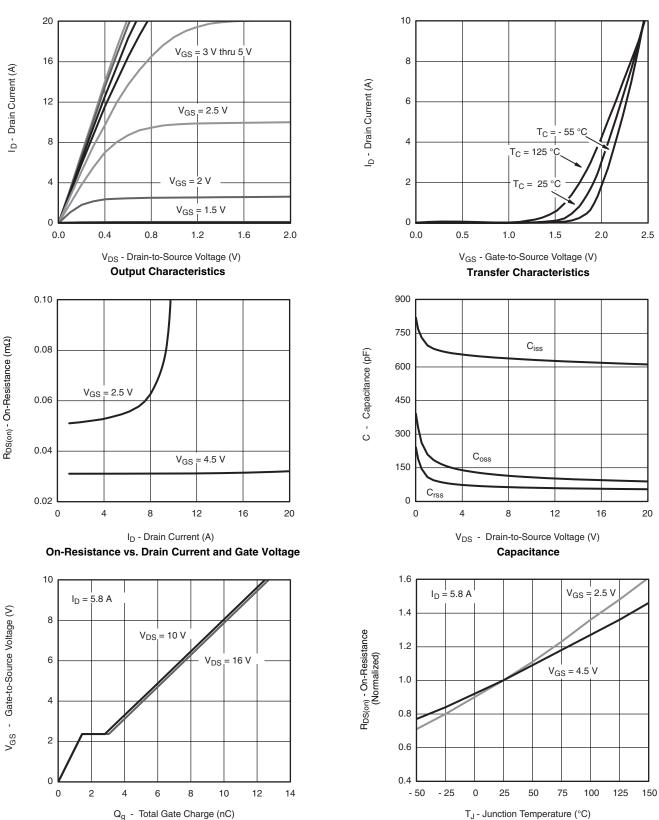
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

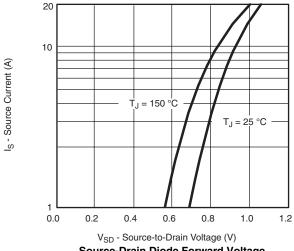


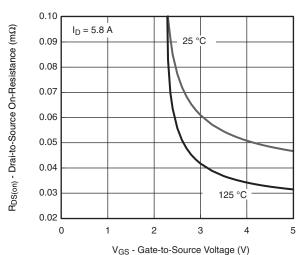
**Gate Charge** 

On-Resistance vs. Junction Temperature

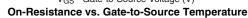
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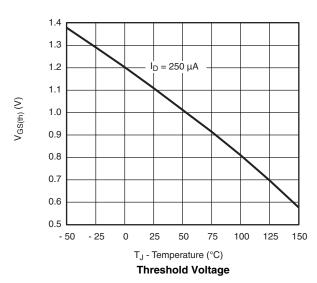
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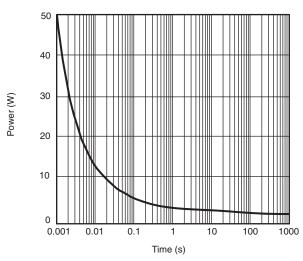




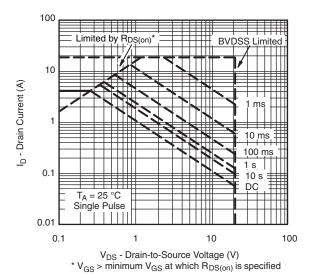
Source-Drain Diode Forward Voltage







Single Pulse Power, Junction-to-Ambient



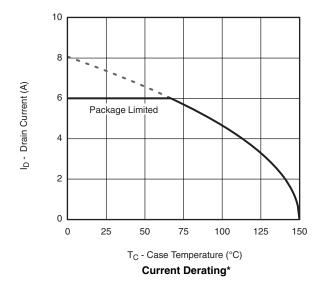
Safe Operating Area, Junction-to-Ambient

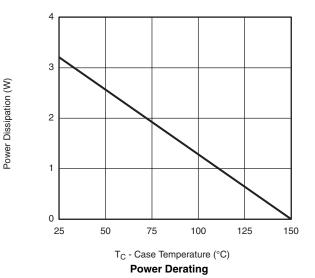




# Vishay Semiconductors

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



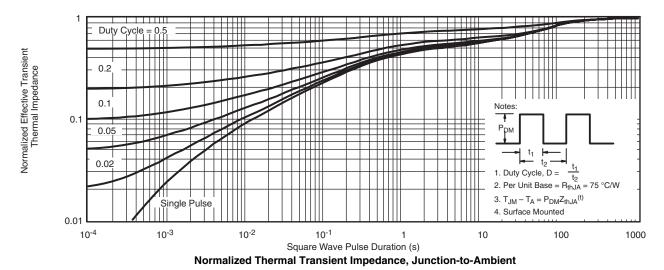


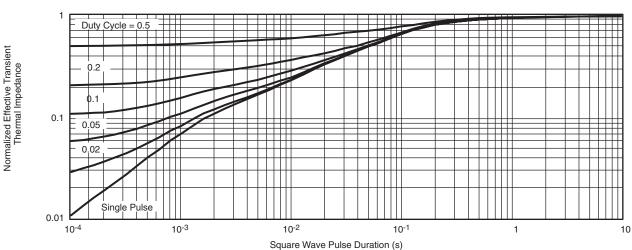
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppq?73772">www.vishay.com/ppq?73772</a>.

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